

L37-3S 導熱矽膠 Thermal Pad



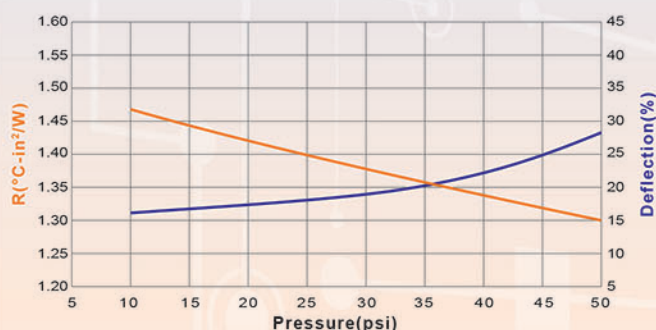
產品特性 Features

- Great reworkability 重工性佳
- High softness and compressibility 柔軟及回彈性好
- Natural tack 具自黏性
- Easy to assemble 容易施工
- Shock & vibration absorber 減震緩衝

產品應用端 Applications

- Low middle range applications 中低階產品
- Electronic components: IC, CPU, MOS, LED, Mother Board, Power Supply, Heat Sink, LCD-TV, Notebook, PC, Telecom Device, Wireless Hub, DDR II Module, DVD Applications, Hand-set applications etc.

熱阻抗VS.壓力VS.變形量示意圖 Thermal Resistance VS. Pressure VS. Deflection



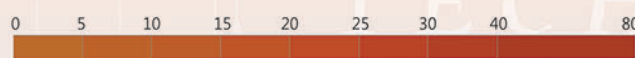
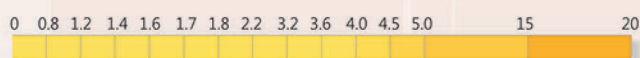
Pressure(psi)	R(°C-in²/W)	Deflection(%)
10	1.47	16
30	1.38	19
50	1.3	28

產品物性 Properties

● REACH Compliant 符合REACH規範 ● RoHS Compliant 符合RoHS規範 ● UL Compliant 符合UL規範

Thermal Conductivity 導熱係數 : 1.95 W/mK

Hardness 軟硬度 : 55 (Shore 00)

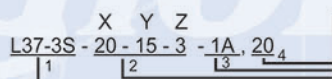
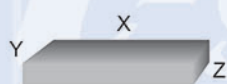


Testing sample thickness: 1.0mm

In "Thermal resistance V.S. Pressure V.S. Deflection" chart, L37-3S provides low thermal impedance. The pressure gets higher, the thermal impedance gets lower, and deflection percentage gets higher. L37-3S provides good compliance and softness.

Properties	L37-3S	Unit	Tolerance	Test Method
Thermal Conductivity 導熱係數	1.95	W / mK	±0.19	ASTM D5470
Thickness 厚度 (the thickness can be ordered) (可依客戶所需厚度生產)	0.3~20	mm	-	ASTM D374
	0.0118~0.787	inch	-	ASTM D374
Color 顏色	Yellow黃	-	-	Visual目視
Flame Rating 耐燃等級	V-0	-	-	UL 94
Dielectric Breakdown Voltage 耐電壓	13	KV / mm	±1.3	ASTM D149
Weight Loss 重量損失	<1	%	-	ASTM E595
Density 密度	2.21	g / cm³	±0.2	ASTM D792
Working Temperature 工作溫度	-40~+200	°C	-	-
Volume Resistance 體積阻抗	>10 ¹⁰	Ohm-m	-	ASTM D257
Elongation 延展率	350	%	-	ASTM D412
Tensile Strength 抗拉強度	8	Kgf / cm²	-	ASTM D412
Standard Shape 標準形狀	Sheet ones單片狀	-	-	-
Hardness 硬度	55	Shore 00	±10	ASTM D2240

Need samples? 樣品需求? Available to apply adhesive 可依需求背膠 Pre-cut for different shapes 可依需求沖型裁切



1. Choose the P/N
2. Fill into size: X,Y,Z
3. Apply the adhesive or not? 0=none, 1A= one side, 2A= two sides
4. Fill the quantity you need